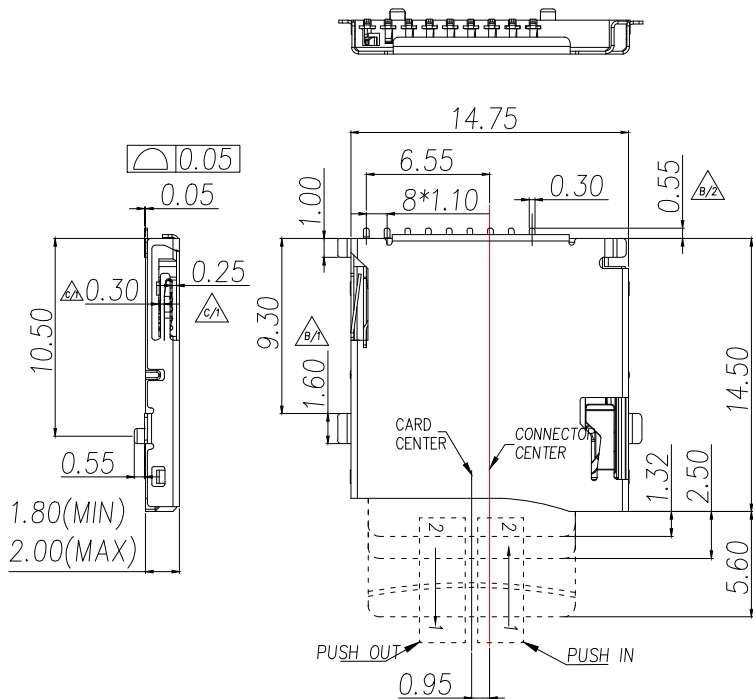


Specification:

1.Electrical Characteristics:

Contact Current Rating:0.5 Amperes.
Dielectric Withstanding Voltage:AC500V r.m.s.
Insulation Resistance:1000 MΩ Minimum.
Contact Resistance: 40 mΩ Maximum.

2.Environmental:

Operating Temperature:-25℃~+90℃.

3.Environmental:

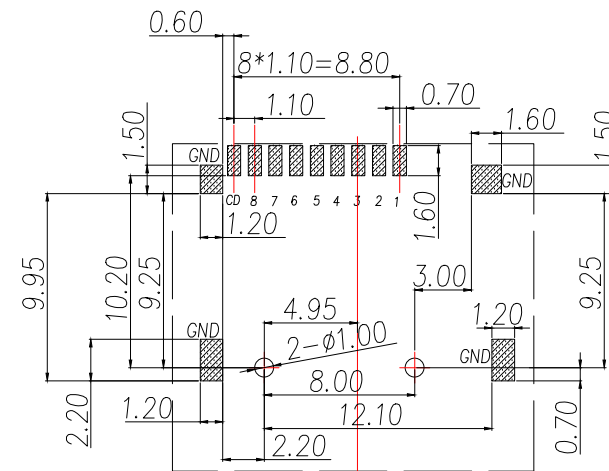
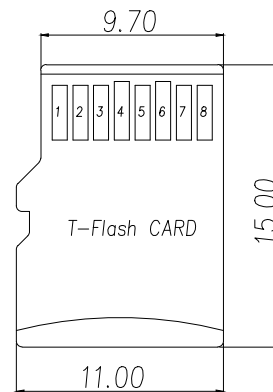
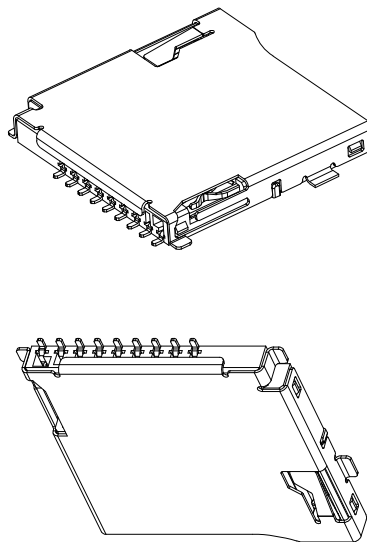
Mating Cycles:5,000 Insertions.

4.Mechanical Characteristics:

Card Push Insertion/Out Force:0.2~1.40kgf.
Contact Separation Force:0.20kgf Minimum.

5.Material:

Insulator:HI-Temp Plastic UL 94V-0 Rated.
Contact:Copper Alloy(t=0.15mm).
Shell:Stainless Steel(t=0.15mm).
Spring:SWP.



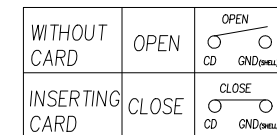
PAD AREA

KEEP OUT AREA

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

Circuit Diagram for Detect Switch

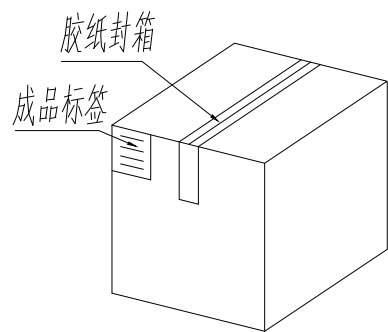
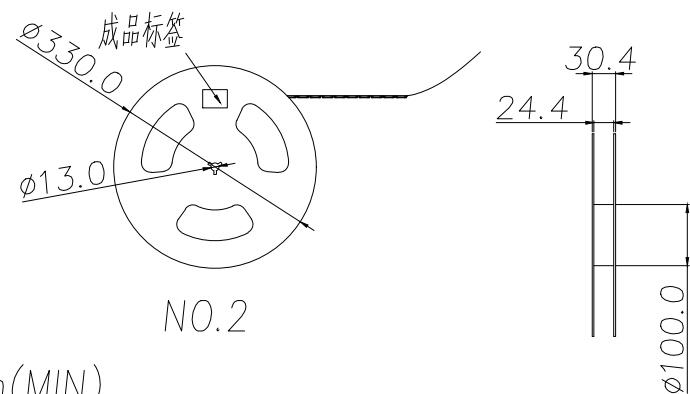
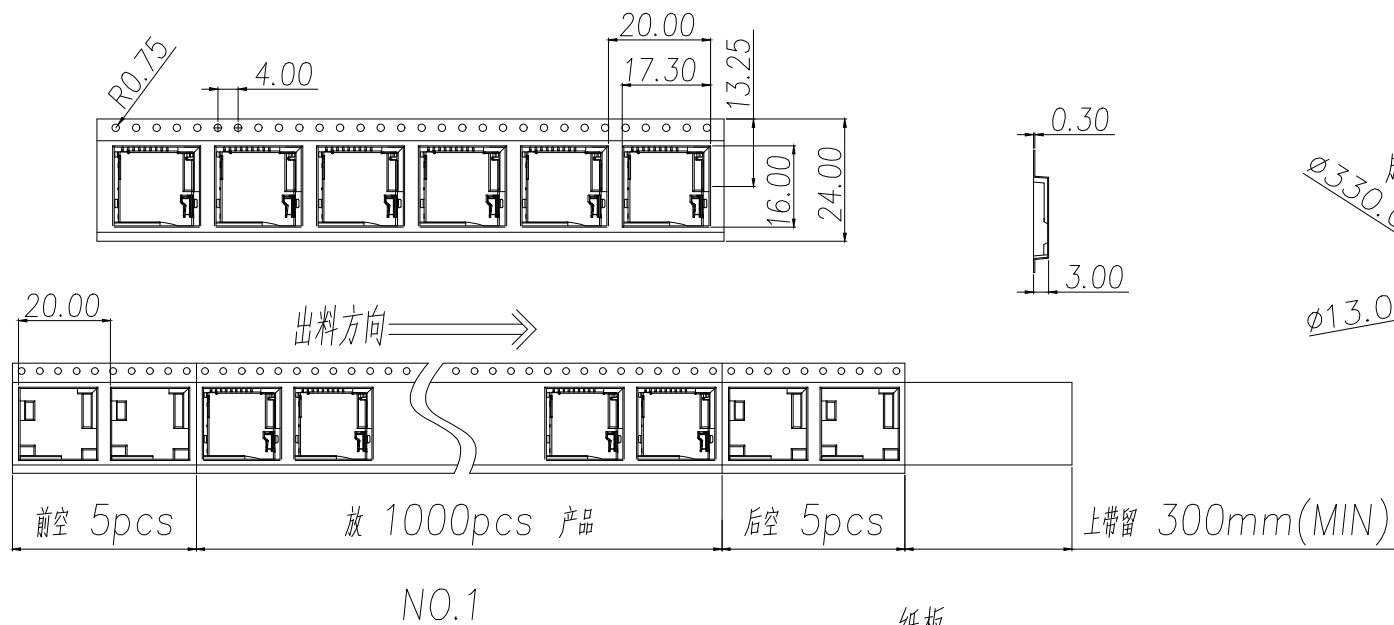


TF CARD PIN DEFINE

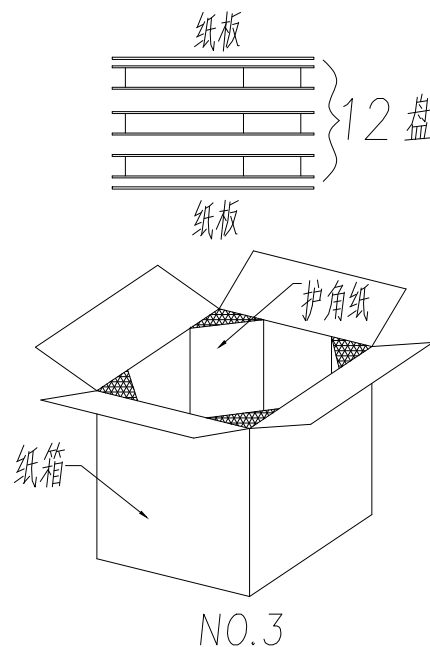
PIN NO.	NAME	YYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DATO	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)

制图 DRAWN	变更内容 DESCRIPTION	日期 DATE	GENERAL TOLERANCE	制图 DRAWING	EMMA	料号 PART NO.	BX-TF-1.8HJ	版本 REV.	A
			X.±0.35	X.±3°		品名 TITLE	MICRO SD CARD PUSH PUSH SMT 翻模	页次 SHEET	1/1
			.X±0.25	.X'±2°	审核 CHECK	客户料号 CUTM.NO.			
			.XX±0.15		核准 APPROVAL				
					单位 UNITS	MM	比例 SCALE	1:1	

Bossie (博锡)



纸箱规格: 340*340*385
NO.4



NO.3

1. 材质要求:

- 1.1 纸箱的材质为K=K; 外形尺寸为34*34*38.5;
- 1.2 卷盘的材质为PS, 卷盘的外形尺寸为 $\phi 330 \times 30.4$;
- 1.3 卷带的材质为PS, 卷带的外形尺寸为20200*24.00*3.0mm;

2. 包装方式:

- 2.1 将卷带放入包装机后, 前空5PCS, 后放产品1000PCS, 再后空 5PCS; 上带留300MM长度。
- 2.2 将包装好的产品从包装机上取下并包装好, 贴上内盘标签;
- 2.3 把累叠好的12 盘叠放入纸箱中共计12Kset, 上下放纸板, 纸箱四个角塞护角纸;
- 2.4 把包装好的成品打包封箱, 并在纸箱外贴上标签

制图 DRAWN	变更内容 DESCRIPTION	日期 DATE	GENERAL TOLERANCE		制图 DRAWING	料号 PART NO.	BX-TF-1.8HJ	版本 REV.	A
			X.±0.35	X.±3°	审核 CHECK	品名 TITLE	MICRO SD CARD PUSH PUSH SMT 封装	页次 SHEET	1/1
			.X±0.25	.X°±2°	核准 APPROVAL	客户料号 CUTM.NO.			
			.XX±0.15		单位 UNITS	比例 SCALE	1:1	Bossie (博锡)	